





BTA12, BTB12, T12xx

12 A Snubberless™, logic level and standard triacs

Features

- Medium current triac
- Low thermal resistance with clip bonding
- Low thermal resistance insulation ceramic for insulated BTA
- High commutation (4Q) or very high commutation (3Q) capability
- BTA series UL1557 certified (File ref: 81734)
- Packages are RoHS (2002/95/EC) compliant

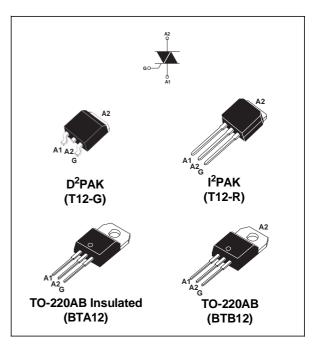
Applications

ON/OFF or phase angle function in applications such as static relays, light dimmers and appliance motors speed controllers.

The snubberless versions (BTA/BTB...W and T12 series) are especially recommended for use on inductive loads, because of their high commutation performances. The BTA series provides an insulated tab (rated at 2500 V RMS).

Description

Available either in through-hole or surface-mount packages, the **BTA12**, **BTB12** and **T12xx** triac series is suitable for general purpose mains power AC switching.



Order code

See Ordering information on page 11

Symbol	Parameter	T12xx	BTA12 ⁽¹⁾	BTB12
I _{T(RMS)}	RMS on-state current	12	12	12
V _{DRM} /V _{RRM}	Repetitive peak off-state voltage	600/800	600/800	600/800
I _{GT} (Snubberless)	Triggering gate current	10/35/50	5/10/35/50	5/10/35/50
I _{GT} (Standard)	Triggering gate current	-	35/50	35/50

Table 1. Device summary

1. Insulated

TM: Snubberless is a trademark of STMicroelectronics

1 Characteristics

Symbol	Param	Parameter					
I _{T(RMS)}	RMS on-state current (full sine wave)	I ² PAK / D ² PAK / TO-220AB	$T_{c} = 105^{\circ} C$	12	A		
. (TO-220AB Ins.	$T_c = 90^\circ C$				
	Non repetitive surge peak on-state	F = 50 Hz	t = 20 ms	120	А		
I_{TSM} current (full cycle, T_j initial = 25° C) $F = 60 \text{ Hz}$		F = 60 Hz	t = 16.7 ms	126	А		
l ² t	I ² t Value for fusing	t _p = 10 ms	78	A ² s			
dl/dt	Critical rate of rise of on-state current I_G = 2 x I_{GT} , t_r \leq 100 ns	F = 120 Hz	T _j = 125° C	50	A/µs		
V _{DSM} /V _{RSM}	Non repetitive surge peak off-state voltage	t _p = 10 ms	T _j = 25° C	V _{DRM} /V _{RRM} + 100	V		
I _{GM}	Peak gate current	t _p = 20 μs	T _j = 125° C	4	А		
P _{G(AV)}	Average gate power dissipation		T _j = 125° C	1	W		
T _{stg} T _j	Storage junction temperature range Operating junction temperature range			- 40 to + 150 - 40 to + 125	°C		

Table 2. Absolute maximum ratings

Table 3. Electrical characteristics (Tj = 25°C, unless otherwise specified) Snubberless and logic level (3 quadrants)

Symbol	Test conditions	Quedrant			T12xx		I	BTA12	BTB1	2	Unit
Symbol	Test conditions	Quadrant		T1210	T1235	T1250	тw	SW	CW	BW	Unit
I _{GT} ⁽¹⁾	V _D = 12 V	- -	MAX.	10	35	50	5	10	35	50	mA
V _{GT}	$R_L = 30 \Omega$	- -	MAX.				1.3				V
V _{GD}	$V_{D} = V_{DRM}$ R _L = 3.3 kΩ T _j = 125° C	1 - 11 - 111	MIN.	0.2			V				
I _H ⁽²⁾	I _T = 100 mA		MAX.	15	35	50	10	15	35	50	mA
	1 - 1 2 1	-	MAX.	25	50	70	10	25	50	70	mA
ΙL	$I_{G} = 1.2 I_{GT}$	II		30	60	80	15	30	60	80	IIIA
dV/dt ⁽²⁾	V _D = 67 %V _{DRM} ga T _j = 125° C	te open	MIN.	40	500	1000	20	40	500	1000	V/µs
	$(dV/dt)c = 0.1 V/\mu s$ T _j = 125° C			6.5			3.5	6.5			
(dl/dt)c ⁽²⁾	$(dV/dt)c = 10 V/\mu s$ T _j = 125° C		MIN.	2.9			1	2.9			A/ms
	Without snubber T _j = 125° C				6.5	12			6.5	12	

1. Minimum I_{GT} is guaranted at 5% of $I_{GT}\,\text{max}$

2. for both polarities of A2 referenced to A1

Symbol	Test Conditions	Quadrant		BTA12	Unit	
Symbol		Quadrant		С	В	
I _{GT} ⁽¹⁾	$V_{\rm D} = 12 {\rm V} {\rm R_{\rm L}} = 30 \Omega$	- - V	MAX.	25 50	50 100	mA
V _{GT}		ALL	MAX.	1.3		V
V _{GD}	$V_D = V_{DRM} R_L = 3.3 \text{ k}\Omega T_j = 125^{\circ} \text{ C} \qquad \qquad \text{ALL}$		MIN.	0.2		V
I _H ⁽²⁾	I _T = 500 mA		MAX.	25	50	mA
1	1 1 2 1	I - III - IV		40	50	mA
ΙL	$I_{G} = 1.2 I_{GT}$ II MAX.		WAA.	80	100	
dV/dt ⁽²⁾	$V_D = 67\% V_{DRM}$ gate open $T_j = 125^{\circ} C$		MIN.	200	400	V/µs
(dV/dt)c ⁽²⁾	$(dI/dt)c = 5.3 \text{ A/ms} T_j = 125^{\circ} \text{ C}$		MIN.	5	10	V/µs

Table 4.Electrical characteristics ($T_j = 25^{\circ}C$, unless otherwise specified)
standard (4 quadrants)

1. Minimum I_{GT} is guaranted at 5% of I_{GT} max.

for both polarities of A2 referenced to A1.

Table 5. Static characteristics

Symbol	Test	Value	Unit		
V _T ⁽¹⁾	I _{TM} = 17 A t _p = 380 μs	$T_j = 25^\circ C$	MAX.	1.55	V
V _{t0} ⁽¹⁾	Threshold voltage	T _j = 125° C	MAX.	0.85	V
R _d ⁽¹⁾	Dynamic resistance	T _j = 125° C	MAX.	35	mΩ
I _{DRM}		T _j = 25° C	MAX.	5	μA
I _{RRM}				1	mA

1. for both polarities of A2 referenced to A1

Table 6.Thermal resistance

Symbol		Paramete	r	Value	Unit
D	lunction to cope (AC)		I ² PAK / D ² PAK / TO-220AB	1.4	°C/W
R _{th(j-c)}	Junction to case (AC)		TO-220AB insulated	2.3	C/VV
	Junction to ambient	$S^{(1)} = 1 \text{ cm}^2$	D ² PAK	45	
R _{th(j-a)}			TO-220AB / I ² PAK TO-220AB insulated	60	°C/W

1. Copper surface under tab.



16

14

12

10

8

6

4

2

0

0

Figure 1. Maximum power dissipation versus Figure 2. RMS on-state current (full cycle)

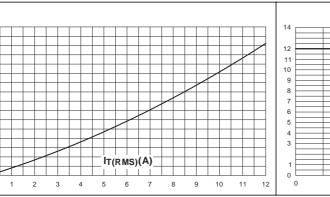
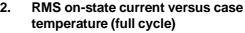


Figure 3. RMS on-state current versus ambient temperature (printed circuit board FR4, copper thickness: 35µm) (full cycle)



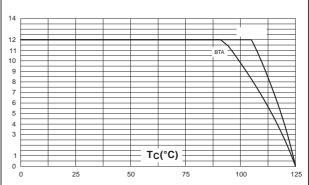


Figure 4. Relative variation of thermal impedance versus pulse duration

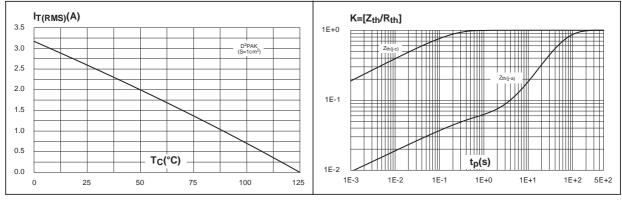


Figure 5. On-state characteristics (maximum Figure 6. values)

Surge peak on-state current versus number of cycles

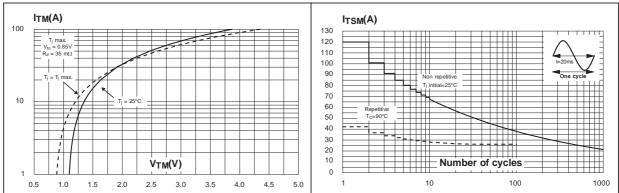
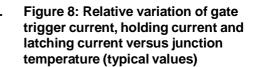


Figure 7. Non-repetitive surge peak on-state Figure 8. current for a sinusoidal pulse with width $t_p < 10$ ms and corresponding value of I^2t



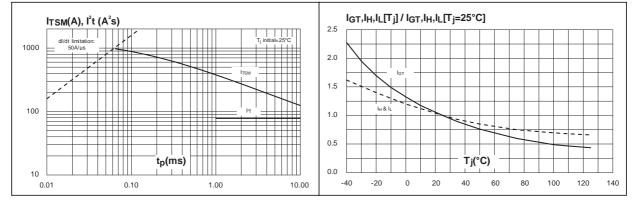
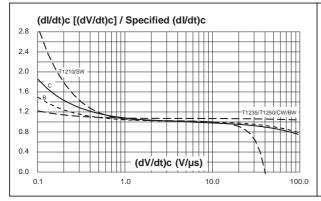
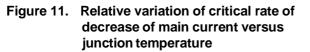
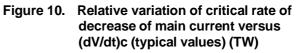
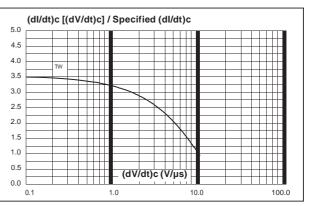


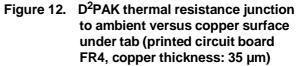
Figure 9. Relative variation of critical rate of decrease of main current versus (dV/dt)c (typical values) (BW/CW/T1210/T1235)

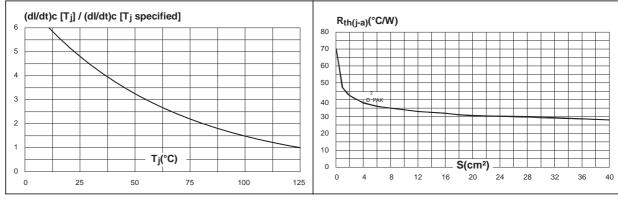






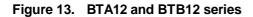






57

2 Ordering information scheme



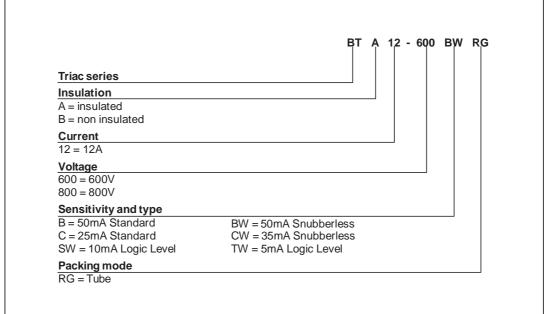


Figure 14. T12xx series

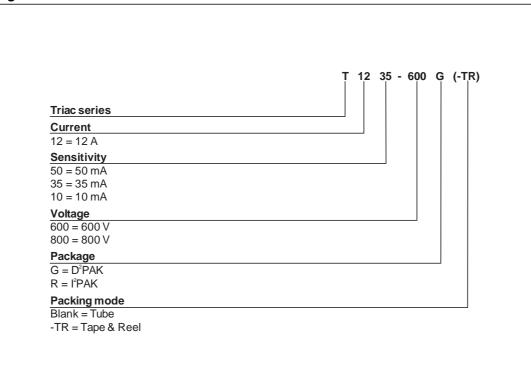


	Table 7.	Product se	elector
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Order code ⁽¹⁾	Voltag	je (xxx)	Sanaitivity	Turne	Deekage
Order code.	600 V	800 V	 Sensitivity 	Туре	Package
BTA/BTB12-xxxBRG	Х	Х	50 mA	Standard	TO-220AB
BTA/BTB12-xxxBWRG	Х	Х	50 mA	Snubberless	TO-220AB
BTA/BTB12-xxxCRG	Х	Х	25 mA	Standard	TO-220AB
BTA/BTB12-xxxCWRG	Х	Х	35 mA	Snubberless	TO-220AB
BTA/BTB12-xxxSWRG	Х	Х	10 mA	Logic Level	TO-220AB
BTA/BTB12-xxxTWRG	Х	Х	5 mA	Logic Level	TO-220AB
T1210-800G	-	Х	10 mA	Logic Level	D ² PAK
T1235-xxxG	Х	Х	35 mA	Snubberless	D ² PAK
T1235-xxxR	Х	Х	35 mA	Snubberless	I ² PAK
T1250-600G	Х	-	50 mA	Snubberless	D ² PAK

1. BTB: non insulated TO-220AB package



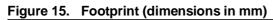
3 Packaging information

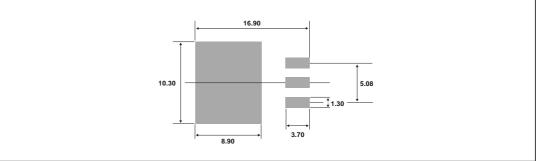
• Epoxy meets UL94, V0

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com.

Dimensions Ref. Millimeters Inches Min. Typ. Max. Min. Тур. Max. 4.30 0.181 4.60 0.169 А 2.49 0.106 A1 2.69 0.098 C.2 A2 0.03 0.23 0.001 0.009 В 0.70 0.93 0.027 0.037 D 1.25 B2 1.40 0.048 0.055 L С 0.45 0.017 0.60 0.024 L3 0.047 0.054 C2 1.21 1.36 D 0.368 8.95 9.35 0.352 Е 10.00 0.393 0.405 10.28 G 4.88 5.28 0.192 0.208 2 mm min FLAT ZONE L 15.00 15.85 0.590 0.624 L2 1.27 1.40 0.050 0.055 L3 1.40 1.75 0.055 0.069 R 0.40 0.016 V2 0° 8° 0° 8°

Table 8. D²PAK dimensions







					Dimer	nsions		
		Ref.	M	illimete	ers		Inches	
			Min.	Тур.	Max.	Min.	Тур.	Max.
	Α,	А	4.30		4.60	0.169		0.181
I E I	<u>c2</u>	A1	2.49		2.69	0.098		0.106
L2		b	0.70		0.93	0.028		0.037
		b1	1.20		1.38	0.047		0.054
	D V4	b2	1.25	1.40		0.049	0.055	
	V V	С	0.45		0.60	0.018		0.024
		c2	1.21		1.36	0.048		0.054
↓	···· • • • • • • • • • • • • • • • • •	D	8.95		9.35	0.352		0.368
L		е	2.44		2.64	0.096		0.104
		Е	10.00		10.28	0.394		0.405
	⊆ , , ,	L	13.10		13.60	0.516		0.535
<	11	L1		3.75			0.148	
		L2	1.27		1.40	0.050		0.055
		V		5°			5°	
		V4		45°			45°	

Table 9.I²PAK dimensions



					Dimer	nsions			
		Ref.	м	illimete	rs		Inches		
			Min.	Тур.	Max.	Min.	Тур.	Max.	
		А	15.20		15.90	0.598		0.625	
		a1		3.75			0.147		
B	b2	a2	13.00		14.00	0.511		0.551	
		В	10.00		10.40	0.393		0.409	
	F	b1	0.61		0.88	0.024		0.034	
14 A	*	b2	1.23		1.32	0.048		0.051	
		С	4.40		4.60	0.173		0.181	
	c2	c1	0.49		0.70	0.019		0.027	
	<u>←→</u> _	c2	2.40		2.72	0.094		0.107	
a2		е	2.40		2.70	0.094		0.106	
	M	F	6.20		6.60	0.244		0.259	
 → I → b1	←→ c1	ØI	3.75		3.85	0.147		0.151	
		14	15.80	16.40	16.80	0.622	0.646	0.661	
		L	2.65		2.95	0.104		0.116	
		12	1.14		1.70	0.044		0.066	
		13	1.14		1.70	0.044		0.066	
		М		2.60			0.102		

Table 10. TO-220AB dimensions (insulated and non-insulated)



4 Ordering information

Table 11.	Ordering information
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Order code	Marking	Package	Weight	Base qty	Delivery mode	
BTA/BTB12-xxxyzRG	BTA/BTB12-xxxyz	TO-220AB	2.3 g	50	Tube	
T1210-xxxG-TR	T1210-xxxG	D ² PAK	1.5 g	1000	Tape and reel	
T1235-xxxG	T1235xxxG	D ² PAK	150	1.5 g	50	Tube
T1235-xxxG-TR	T1235xxxG	DFAN	1.5 g	1000	Tape and reel	
T1235-xxxR	T1235-xxxR	I ² PAK	1.5 g	50	Tube	
T1250-xxxG-TR	T1250xxxG	D ² PAK	1.5 g	1000	Tape and reel	

Note: xxx = voltage, y = sensitivity, z = type

5 Revision history

Table 12. Revision history

Date	Revision	Changes
Sep-2002	6A	Last update.
25-Mar-2005	7	 I²PAK package added. TO-220AB delivery mode changed from bulk to tube.
27-May-2005	8	T1210 added
28-Sep-2007	9	Reformatted to current standards. T1250 added

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